

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Number : 10/595,303 Confirmation No.: 7114
Applicant : Roy KNECHTEL
Filed : April 6, 2006
Title : METHOD AND DEVICE FOR SECURE, INSULATED AND
ELECTRICALLY CONDUCTIVE ASSEMBLING OF TREATED
SEMICONDUCTOR WAFERS
TC/Art Unit : Unassigned
Examiner: : Unassigned

Docket No. : 60291.000048
Customer No. : 21967

SUBMISSION OF VERIFIED ENGLISH TRANSLATION OF APPLICATION

MAIL STOP MISSING PARTS

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicant also submits herewith, in accordance with 37 C.F.R. §1.52(d), an English-language translation of the specification as filed on April 6, 2006, along with the Translator's Declaration executed on April 5, 2006.

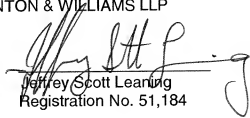
No additional fees are believed due in connection with this filing. However, if it is determined otherwise, the Commissioner is hereby authorized to charge the undersigned's Deposit Account No. 50-0206.

Respectfully submitted,

HUNTON & WILLIAMS LLP

Dated: May 19, 2006
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